

CONTACT: UNDERPLATED: 50 u" MIN Ni.
CONTACT AREA: SELECT GOLD OVER Ni PLATED.
SOLDER TAIL: 100 u" MIN Sn/Pb OVER Ni PLATED.
PED: 100 u" MIN Sn/Pb OVER 50 u" MIN Ni PLATED.

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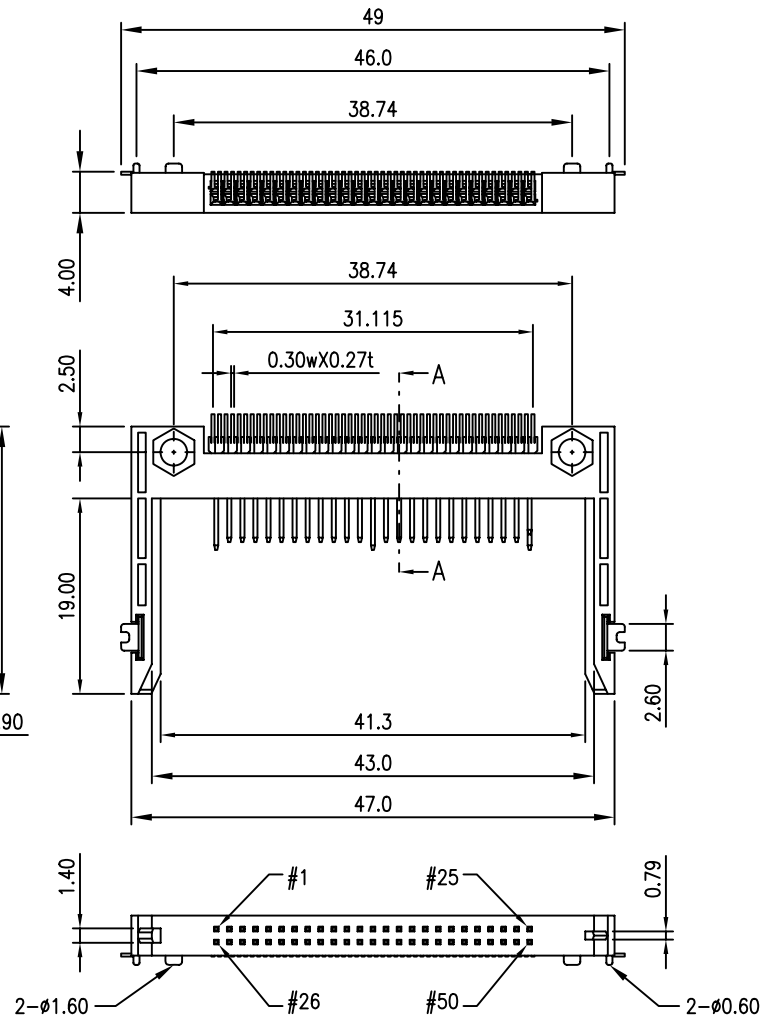
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RECOMMENDED P.C.B. LAYOUT

TABLE		
Pin Type	Interface Dim.	Pin No.
Detect	3.5mm (0.138In.)	25,26
General	4.25mm (0.167In.)	The others
Power	5.0mm (0.197In.)	01,13,38,50



MORETHANALL
CONNECTORS
ASSEMBLIES

PART NO. CFC-PW001ME3-50

DWG NO. CFC-PW001ME3-50

CHECKED BY	CY
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FILE NO.

SCALE 1:1

DRAWING BY

PROJECTION



TOLERANCES ARE

.X ± 0.30
.XX ± 0.20
.XXX ± 0.10
AWG

DESCRIPTION:

CF CARD HEADER TYPE

AREA

REVISIONS

HK

DATE _____

煜倫股份有限公司